## 35-Ball Wafer Level Chip Scale Package (FQB) - 2.821x2.529 mm Body [WLCSP]

For the most current package drawings, please see the Microchip Packaging Specification located at Note: http://www.microchip.com/packaging D В NOTE 1 С Ε (DATUM B) (DATUM A) 0.03 C **TOP VIEW** 0.03 SEE DETAIL A SEATING PLANE SIDE VIEW F <u>e</u>2 Ε D E1 С В NOTE 1 35X Øb C A B 0.15(M)0.05(M)**BOTTOM VIEW**